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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re the application of:

Applicant :	Anthony Chiu	Docket No :	00-C-016
Serial No :	09/656,984	Group No :	2823
Filed :	September 7, 2000	Examiner :	Khiem D. Nguyen
For :	Surface Mount Package With Integral Electro- Static Charge Dissipating Ring Using Lead Frame As ESD Device	Confirmation No :	2247

TRANSMITTAL LETTER

Mail Stop Issue Fee
Attention: Official Draftsman
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Allowability (PTO-37) mailed December 3, 2003, for the above-identified patent application, please find enclosed for filing seven (7) sheets of formal drawings.

The Commissioner is hereby authorized to charge any fees which may be required to Deposit Account No. 19-1353. A duplicate copy of this sheet is enclosed.

Respectfully submitted

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CERTIFICATE OF MAILING 37 CFR 1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail with sufficient postage, in an enveloped addressed to: Mail Stop Issue Fee Attention: Official Draftsman Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-14501 on the date below:

March 3, 2004
Date

Angie Rodriguez
Signature